

P-Channel 100 V (D-S) MOSFET

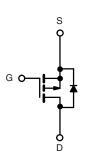
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 100	0.215 at V_{GS} = - 10 V	- 12	11		
- 100	0.234 at V _{GS} = - 4.5 V	- 10	11		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET ٠
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 100	v		
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 25 °C	1-	- 12		
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _C = 70 °C	I _D	- 8	_	
Pulsed Drain Current		I _{DM}	- 30	A	
Avalanche Current		I _{AS}	- 20		
Single Avalanche Energy ^a L = 0.1 mH		E _{AS}	16.2	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	P	32.1 ^b		
	T _A = 25 °C ^c	– P _D –	2.5	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

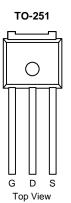
THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W
Junction-to-Case (Drain)	R _{thJC}	3.9	0/10

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



RoHS

COMPLIANT HALOGEN FREE



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•	·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_{D} = -250 \mu A$	- 100			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50		
		$V_{DS} = -100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 10 V, V_{GS} = - 10 V	- 15			Α	
	Б	V _{GS} = - 10 V, I _D = - 3.6 A		0.215			
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.4 A		0.234		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		12		S	
Dynamic ^b	•	·		•			
Input Capacitance	C _{iss}		1055				
Output Capacitance	C _{oss}			65		pF	
Reverse Transfer Capacitance	C _{rss}	1		41		1	
Tatal Cata Charge	Qg	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23		nC	
Total Gate Charge ^c				11			
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -50 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.6 \text{ A}$		3.5			
Gate-Drain Charge ^c	Q _{gd}]		4.8		1	
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			7	14		
Rise Time ^c	t _r	V_{DD} = - 50 V, R_L = 17.2 Ω		12	18	-	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 2.9 A, V_{GEN} = - 10 V, R_g = 1 Ω		33	50	ns	
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings and	nd Characteri	stics T _C = 25 °C ^b					
Continuous Current	ا _S				- 8.8		
Pulsed Current	I _{SM}				- 15	A	
Forward Voltage ^a	V _{SD}	$I_{\rm F}$ = - 2.9 A, $V_{\rm GS}$ = 0 V		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			50	75	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	Α	
Reverse Recovery Charge	Q _{rr}	1 1		98	147	nC	

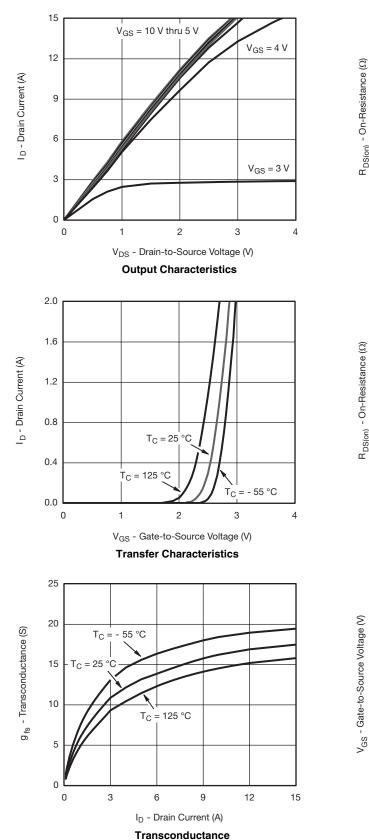
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

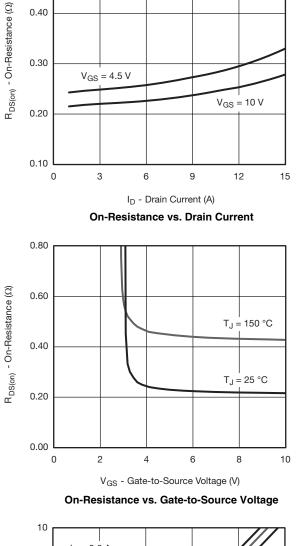
b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



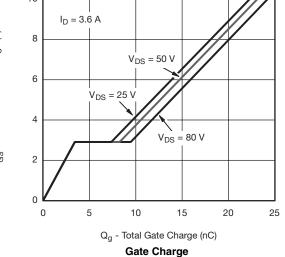


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



0.50

0.40

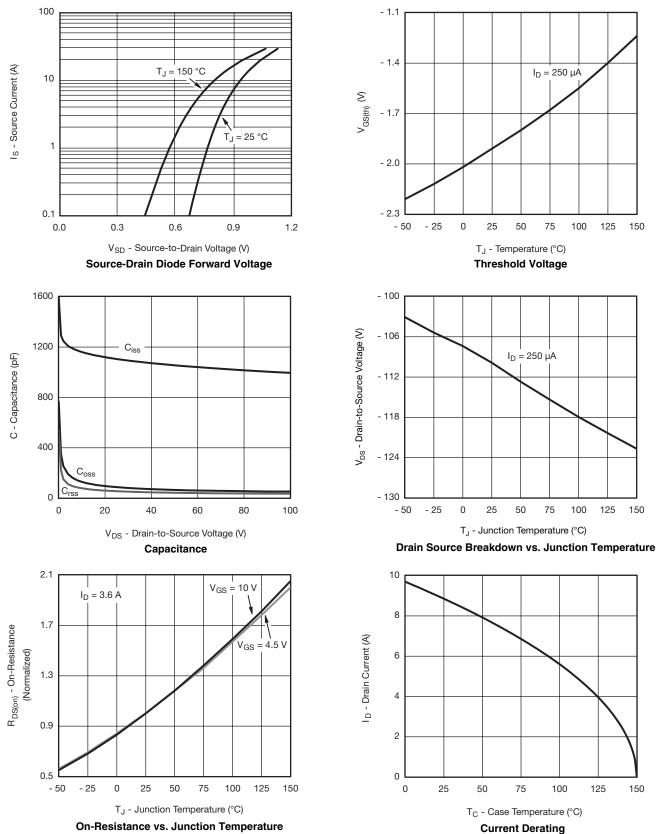




150

150

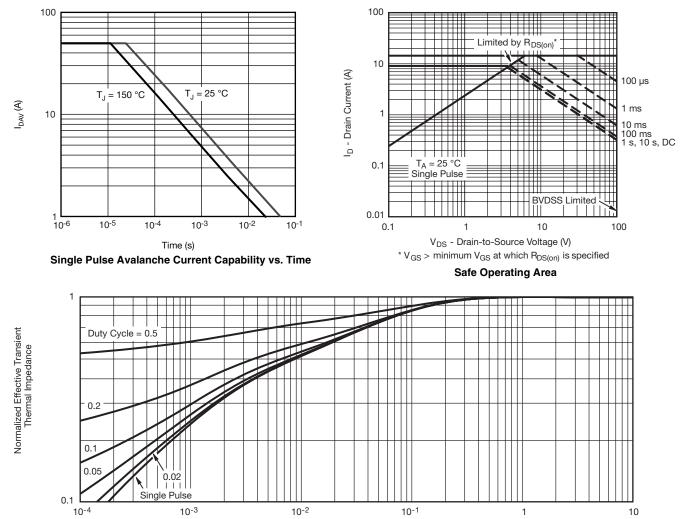
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



150



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

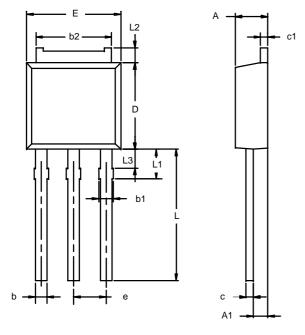


Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

AP15P10GJ-HF



TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

	MILLIMETERS		INCHES		
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090 BSC		
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-0 DWG: 53	3946—Rev. E 346	, 09-Jul-01	1	1	



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